#### PATENT ASSIGNMENT

## Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Jen-Chieh LO	02/01/2010
Yi-Cheng CHEN	02/01/2010
Chia-Ta LAI	02/01/2010

#### RECEIVING PARTY DATA

Name:	Realtek Semiconductor Corp.	
Street Address:	2 Innovation Rd. II, Science Park	
City:	HsinChu	
State/Country:	TAIWAN	
Postal Code:	ode: 30076	

#### PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	12719585	

#### **CORRESPONDENCE DATA**

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ATTORNEY DOCKET NUMBER:	3722/0625PUS1
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NAME OF SUBMITTER: Joe McKinney Muncy

Total Attachments: 2

501112717

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REEL: 024046 FRAME: 0616

# **ASSIGNMENT**

This assignment agreement is applicable to an invention entitled (Invention Title)

RECEIVING DEVICE AND METHOD THEREOF

The PATENT RIGHTS referred to in this agreement are:
(check one)  a patent application for this invention, executed by the ASSIGNOR(S)
concurrently with this assignment.
U.S. patent application Serial No, filed
a U.S. patent application based on PCT International Application
No, filed on (date) (U.S. patent
application Serial No, if known)
U.S. Patent No, issued
The PATENT RIGHTS also include all divisions, reissues, continuations and extensions
of the patents and patent applications identified above.
The PATENT RIGHTS assigned under this agreement are:
(check one) 🗵 U.S. patent rights only.
☐ Worldwide patent rights. In this case, the assignee shall have the
right to claim the benefit of the filing date of any U.S. or foreign
patent application for this invention.
The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose
signature(s) appear(s) on page 2 of this Assignment and any Supplemental Sheets(s).
The ASSIGNEE referred to in this agreement is:
(Name of Assignee) Realtek Semiconductor Corp.
(Address) 2 Innovation Rd. II, Science Park, HsinChu 30076, Taiwan, R.O.C.
The ASSIGNEE is:
(check one)  An Individual.
A Partnership.
A Corporation of <u>Taiwan, R.O.C.</u> (specify state or country)
(other)

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, hereby assign(s) the following rights to the ASSIGNEE, its successors and assigns:

PATENT REEL: 024046 FRAME: 0617 the full and exclusive right to the invention; the entire right, title and interest in and to the PATENT RIGHTS; the right to sue and recover for any past infringement; and, the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable provisions, based on any earlier patent applications for this invention.

As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the commissioner of Patents and Trademarks to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any facts known to the ASSIGNOR(S) respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute renewal, reexamination and reissue applications, execute all necessary assignment papers to cause any and all Letters Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) any attorney and agent who has a power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

Jen-Chieh Lo	Jen-Chieh Lo	2010/2/1
First joint inventor	Signature	Date
Yi-Cheng Chen Second joint inventor	Yi-thing CHen Signature	2010/2/1 Date
Chia-Ta Lai	chia-Ta Lai	2010/2/1
Third joint inventor	Signature	Date
Fourth joint inventor	Signature	Date
Fifth joint inventor	Signature	Date

PATENT REEL: 024046 FRAME: 0618